

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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Assignment ID: PATI47880

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yong-Sik JEONG	01/04/2006
RECEIVING PARTY DATA	
Company Name:	MagnaChip Semiconductor, Ltd.
Street Address:	1 Hyangjeong-dong, Heungduk-gu, Chungcheongbuk-do
City:	Cheongju-si
State/Country:	KOREA, REPUBLIC OF
Postal Code:	361-725
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12228211
CORRESPONDENCE DATA	
Fax Number:	2023153758
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	NSIP Law
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Address Line 4:	Washington, DISTRICT OF COLUMBIA 20035
ATTORNEY DOCKET NUMBER:	023103.0044
NAME OF SUBMITTER:	Isabelle Osborne
SIGNATURE:	Isabelle Osborne
DATE SIGNED:	02/23/2024
Total Attachments: 1	
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ASSIGNMENT BEST AVAILABLE COPY

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

JEONG, Yong-Sik

Hereby sells, assigns, and transfers to:

MagnaChip Semiconductor, Ltd.

a corporation of Republic of Korea, having a principal place of business at:

1 Hyangjeong-dong, Heungduk-gu, Cheongju-si, Chungcheongbuk-do, 361-725, Republic of Korea

("Assignee"), and its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

[] which has been executed by the undersigned concurrently herewith,

[X] which was filed on October 12, 2005 and assigned Serial No. 11/250,052,

and is entitled:

NON-VOLATILE MEMORY DEVICE AND METHOD FOR FABRICATING
THE SAME

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: January 04, 2006



Name: **JEONG, Yong-Sik**

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